

Kingtronics®

ES2A THRU ES2J

SURFACE MOUNT SUPER FAST RECTIFIER

VOLTAGE RANGE 50 to 600Volts **CURRENT** 2.0 Ampere

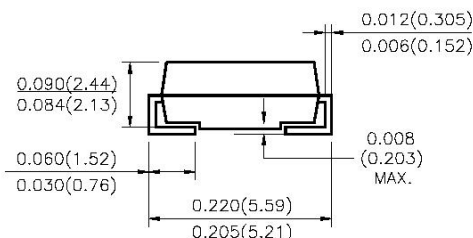
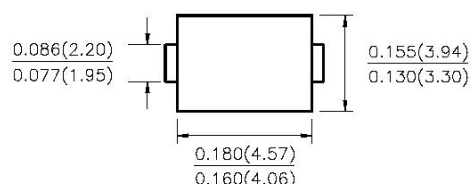
FEATURES

- Plastic package has Underwrites Laboratory Flammability Classification 94V-0
- Glass passivated chip junction
- Built-in strain relief
- Super Fast switching speed for high efficiency
- High temperature soldering guaranteed: 250°C/10 seconds

MECHANICAL DATA

- Case:** JEDED DO-214AA transfer molded plastic
- Terminals:** Solder plated, Solderable per MIL-STD-750, Method 2026
- Polarity:** Color band denotes cathode end
- Weight:** 0.003 ounce, 0.093 gram

DO-214AA (SMB)



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Dimensions in inches and (millimeters)

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load derate current by 20%.

PARAMETER	SYMBOLS	ES2A	ES2B	ES2C	ES2D	ES2E	ES2G	ES2J	UNIT
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	50	100	150	200	300	400	600	Volts
Maximum RMS Voltage	V_{RMS}	35	70	105	140	210	280	420	Volts
Maximum DC Blocking Voltage	V_{DC}	50	100	150	200	300	400	600	Volts
Maximum Average Forward Rectified Current at $T_L = 100^\circ\text{C}$	$I_{(AV)}$	2.0							Amps
Peak Forward Surge Current 8.3ms single half sine wave superimposed on rated load (JEDEC method)	I_{FSM}	50							Amps
Maximum Instantaneous Forward Voltage @ 2.0A	V_F	0.95			1.25		1.7		Volts
Maximum DC Reverse Current at rated DC Blocking voltage per element	$T_A = 25^\circ\text{C}$	5.0							μA
	$T_A = 125^\circ\text{C}$	200							
Maximum Reverse Recovery Time Test conditions $I_F = 0.5\text{A}$, $I_R = 1.0\text{A}$, $I_{RR} = 0.25\text{A}$	t_{rr}	35							nS
Typical Junction Capacitance (Measured at 1.0MHz and applied reverse voltage of 4.0V)	C_J	25			208				pF
Typical Thermal Resistance (Note 1)	$R_{\theta JA}$	75							$^\circ\text{C/W}$
	$R_{\theta JL}$	17							
Operating Junction Temperature Range	T_J	-55 to +150							$^\circ\text{C}$
Storage Temperature Rang	TSTG	-55 to +150							$^\circ\text{C}$

- Notes:
- Thermal resistance from Junction to ambient and from junction to lead mounted on P.C.B. with 0.3"×0.3"(8.0mm × 8.0mm) copper pad areas.

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RATINGS AND CHARACTERISTIC CURVES

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

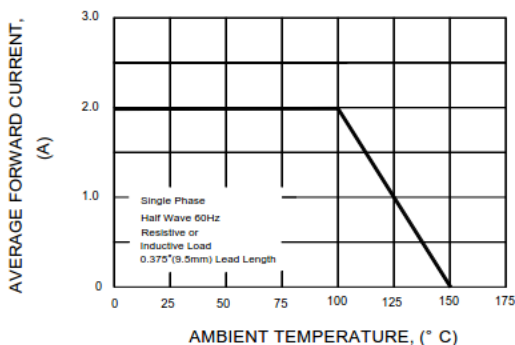


FIG.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

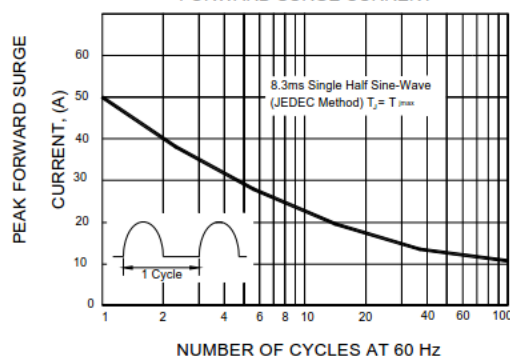


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

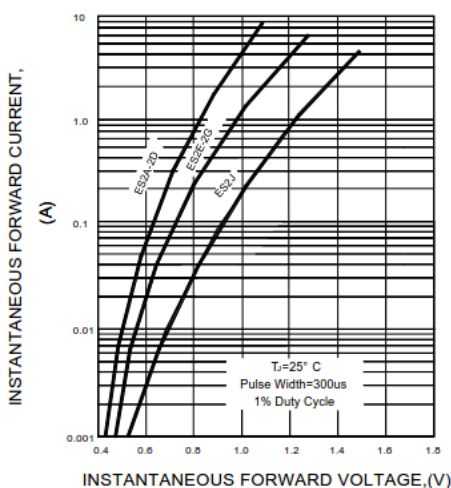


FIG.4-TYPICAL REVERSE CHARACTERISTICS

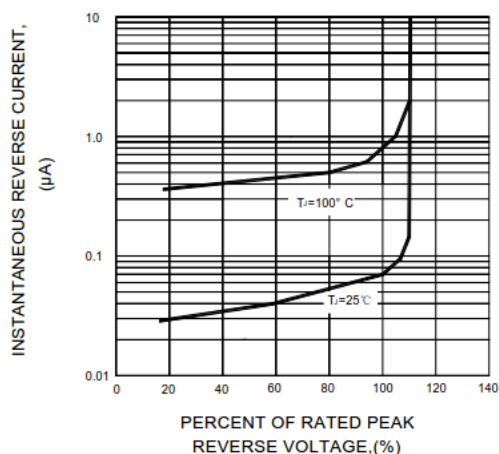


FIG.5-TYPICAL JUNCTION CAPACITANCE

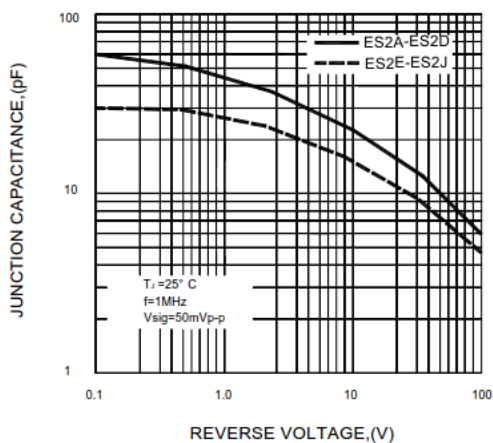
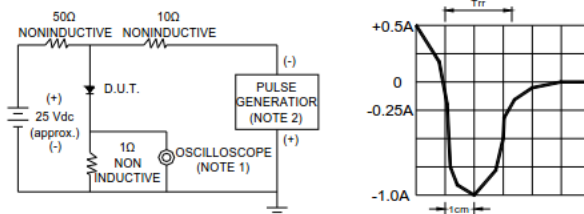


FIG.6-TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTIC



NOTES : 1. Rise Time=7ns max. Input Impedance= 1 magohm. 22pF
2. Rise time=10ns max. Source Impedance= 50 ohms

SET TIME BASE FOR 50/100ns/cm

Note: Specifications are subject to change without notice.